

# Radiation Hardened 36V Quad Precision Low Power Operational Amplifier With Enhanced SET Performance

## ISL70419SEH

The ISL70419SEH contains four very high precision amplifiers featuring the perfect combination of low noise vs power consumption. Low offset voltage, low  $I_{BIAS}$  current and low temperature drift making them the ideal choice for applications requiring both high DC accuracy and AC performance. The combination of high precision, low noise, low power and small footprint provides the user with outstanding value and flexibility relative to similar competitive parts.

Applications for these amplifiers include precision active filters, medical and analytical instrumentation, precision power supply controls, and industrial controls.

The ISL70419SEH is offered in a 14 Ld hermetic ceramic flatpack package. The device is offered in an industry standard pin configuration and operates over the extended temperature range from -55°C to +125°C.

## Applications

- Precision instrumentation
- Spectral analysis equipment
- Active filter blocks
- Thermocouples and RTD reference buffers
- Data acquisition
- Power supply control

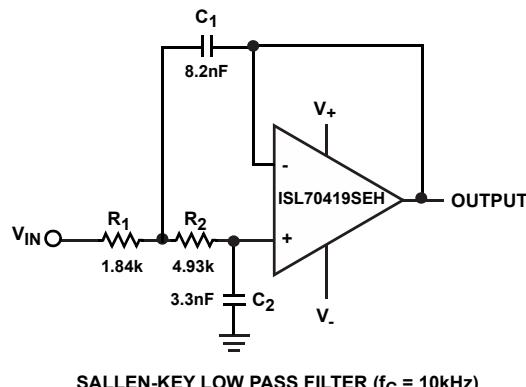


FIGURE 1. TYPICAL APPLICATION

## Features

- Electrically screened to DLA SMD# [5962-14226](#)
- Low input offset voltage .....  $\pm 110\mu\text{V}$ , Max.
- Superb offset temperature coefficient .....  $1\mu\text{V}/^\circ\text{C}$ , Max.
- Input bias current .....  $\pm 15\text{nA}$ , Max.
- Input bias current TC .....  $\pm 5\text{pA}/^\circ\text{C}$ , Max.
- Low current consumption .....  $440\mu\text{A}$
- Voltage noise .....  $8\text{nV}/\sqrt{\text{Hz}}$
- Wide supply range ..... 4.5V to 36V
- Operating temperature range ..... -55°C to +125°C
- Radiation environment
  - SEB  $\text{LET}_{TH}$  ( $V_S = \pm 18\text{V}$ ) .....  $86.4\text{ MeV} \cdot \text{cm}^2/\text{mg}$
  - SET recovery time .....  $\leq 10\mu\text{s}$  at  $60\text{ MeV} \cdot \text{cm}^2/\text{m}$
  - SEL immune (SOI process)
  - Total dose HDR (50-300rad(Si)/s) ..... 300krad(Si)
  - Total dose LDR (10mrad(Si)/s) ..... 100krad(Si) \*

\* Product capability established by initial characterization. The EH version is acceptance tested on a wafer-by-wafer basis to 50krad(Si) at low dose rate.

## Related Literature

[AN1936](#), ISL70419SEHEV1Z Evaluation Board User's Guide

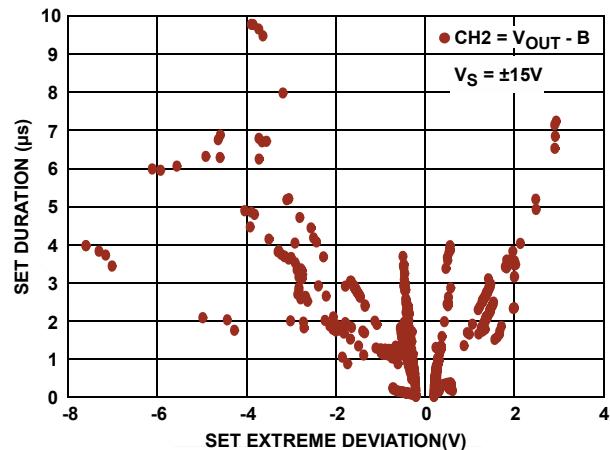


FIGURE 2. SET DEVIATION vs DURATION FOR LET =  $60\text{ MeV} \cdot \text{cm}^2/\text{mg}$

## Ordering Information

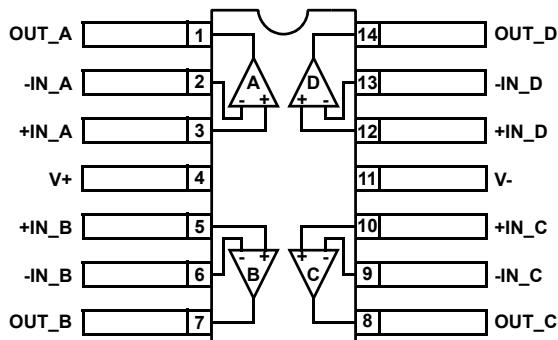
| ORDERING/SMD NUMBER<br><small>(Note 2)</small> | PART NUMBER<br><small>(Note 1)</small> | TEMPERATURE RANGE<br>(°C) | PACKAGE<br>(RoHS Compliant) | PKG.<br>DWG. # |
|--|--|---------------------------|-----------------------------|----------------|
| 5962F1422601VXC                                | ISL70419SEHVF                          | -55 to +125               | 14 Ld Flatpack with EPAD    | K14.C          |
| ISL70419SEHF/PROTO                             | ISL70419SEHF/PROTO                     | -55 to +125               | 14 Ld Flatpack with EPAD    | K14.C          |
| 5962F1422601V9AX                               | ISL70419SEHVX                          | -55 to +125               | DIE                         |                |
| ISL70419SEHX/SAMPLE                            | ISL70419SEHX/SAMPLE                    | -55 to +125               | DIE                         |                |
| ISL70419SEHEV1Z                                | Evaluation Board                       |                           |                             |                |

## NOTES:

1. These Intersil Pb-free Hermetic packaged products employ 100% Au plate - e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations.
2. Specifications for Rad Hard QML devices are controlled by the Defense Logistics Agency Land and Maritime (DLA). The SMD numbers listed in the "Ordering Information" table must be used when ordering.

## Pin Configuration

ISL70419SEH  
(14 LD FLATPACK)  
TOP VIEW



## Pin Descriptions

| PIN NUMBER | PIN NAME | EQUIVALENT CIRCUIT | DESCRIPTION  |
|------------|----------|--------------------|--|
| 1          | OUT_A    | Circuit 2          | Amplifier A output                                 |
| 2          | -IN_A    | Circuit 1          | Amplifier A inverting input                        |
| 3          | +IN_A    | Circuit 1          | Amplifier A non-inverting input                    |
| 4          | V+       | Circuit 3          | Positive power supply                              |
| 5          | +IN_B    | Circuit 1          | Amplifier B non-inverting input                    |
| 6          | -IN_B    | Circuit 1          | Amplifier B inverting input                        |
| 7          | OUT_B    | Circuit 2          | Amplifier B output                                 |
| 8          | OUT_C    | Circuit 2          | Amplifier C output                                 |
| 9          | -IN_C    | Circuit 1          | Amplifier C inverting input                        |
| 10         | +IN_C    | Circuit 1          | Amplifier C non-inverting input                    |
| 11         | V-       | Circuit 3          | Negative power supply                              |
| 12         | +IN_D    | Circuit 1          | Amplifier D non-inverting input                    |
| 13         | -IN_D    | Circuit 1          | Amplifier D inverting input                        |
| 14         | OUT_D    | Circuit 2          | Amplifier D output                                 |
|            | EPAD     | N/A                | EPAD under Package (Unbiased, tied to package lid) |

**CIRCUIT 1**

**CIRCUIT 2**

**CIRCUIT 3**

**Absolute Maximum Ratings**

|   |                       |
|---|-----------------------|
| Maximum Supply Voltage .....  | 42V                   |
| Maximum Supply Voltage (LET = 86.4 MeV • cm <sup>2</sup> /mg) ..... | 36V                   |
| Maximum Differential Input Current .....                            | 20mA                  |
| Maximum Differential Input Voltage .....                            | 20V                   |
| Min/Max Input Voltage .....   | V- -0.5V to V+ + 0.5V |
| Max/Min Input current for Input Voltage >V+ or <V- .....            | ±20mA                 |
| Output Short-Circuit Duration (1 output at a time) .....            | Indefinite            |
| ESD Rating  |                       |
| Human Body Model (Tested per MIL-PRF-883 3015.7).....               | 2kV                   |
| Machine Model (Tested per EIA/JESD22-A115-A).....                   | 200V                  |
| Charged Device Model (Tested per JESD22-C101D) .....                | 750V                  |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

## NOTES:

3.  $\theta_{JA}$  is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief [TB379](#).
4. For  $\theta_{JC}$ , the "case temp" location is the center of the package underside.

**Electrical Specifications**  $V_S \pm 15V$ ,  $V_{CM} = 0$ ,  $V_O = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted. **Boldface limits apply across the operating temperature range, -55°C to +125°C; over a total ionizing dose of 300krad(SI) with exposure at a high dose rate of 50 - 300rad(SI)/s; or across a total ionizing dose of 50krad(SI) with exposure at a low dose rate of <10mrad(SI)/s.**

| PARAMETER  | DESCRIPTION                                  | TEST CONDITIONS                                      | MIN<br>( <a href="#">Note 5</a> )     | TYP         | MAX<br>( <a href="#">Note 5</a> ) | UNITS |
|------------|--|--|---------------------------------------|-------------|-----------------------------------|-------|
| $V_{OS}$   | Input Offset Voltage                         |  |                                       | 10          | 85                                | µV    |
|            |  |  |                                       |             | <b>110</b>                        | µV    |
| $TCV_{OS}$ | Offset Voltage Drift                         | guaranteed by characterization not tested            |                                       | 0.1         | <b>1</b>                          | µV/°C |
| $I_B$      | Input Bias Current                           |  | -2.5                                  | 0.08        | 2.5                               | nA    |
|            |  |  | $T_A = -55^\circ C$ to $+125^\circ C$ | -5          |                                   | nA    |
|            |  |  | over high and low dose radiation      | -15         |                                   | nA    |
| $TCI_B$    | Input Bias Current Temperature Coefficient   | guaranteed by characterization not tested            | <b>-5</b>                             | <b>1</b>    | <b>5</b>                          | pA/°C |
| $I_{OS}$   | Input Offset Current                         |  | -2.5                                  | 0.08        | 2.5                               | nA    |
|            |  |  | $T_A = -55^\circ C$ to $+125^\circ C$ | -3          |                                   | nA    |
|            |  |  | over high and low dose radiation      | -10         |                                   | nA    |
| $TCI_{OS}$ | Input Offset Current Temperature Coefficient | guaranteed by characterization not tested            | <b>-3</b>                             | <b>0.42</b> | <b>3</b>                          | pA/°C |
| $V_{CM}$   | Input Voltage Range                          | guaranteed by CMRR test                              | <b>-13</b>                            |             | <b>13</b>                         | V     |
| CMRR       | Common-Mode Rejection Ratio                  | $V_{CM} = -13V$ to $+13V$                            | 120                                   | 145         |                                   | dB    |
|            |  |  | <b>120</b>                            |             |                                   | dB    |
| PSRR       | Power Supply Rejection Ratio                 | $V_S = \pm 2.25V$ to $\pm 20V$                       | 120                                   | 145         |                                   | dB    |
|            |  |  | <b>120</b>                            |             |                                   | dB    |
| $A_{VOL}$  | Open-Loop Gain                               | $V_O = -13V$ to $+13V$ , $R_L = 10k\Omega$ to ground | 3,000                                 | 14,000      |                                   | V/mV  |
| $V_{OH}$   | Output Voltage High                          | $R_L = 10k\Omega$ to ground                          | 13.5                                  | 13.7        |                                   | V     |
|            |  |  | <b>13.2</b>                           |             |                                   | V     |
|            |  | $R_L = 2k\Omega$ to ground                           | 13.3                                  | 13.55       |                                   | V     |
|            |  |  | <b>13.0</b>                           |             |                                   | V     |

**Thermal Information**

|  |                      |                           |
|--|----------------------|---------------------------|
| Thermal Resistance (Typical)                       | $\theta_{JA}$ (°C/W) | $\theta_{JC}$ (°C/W)      |
| 14 Ld Flatpack ( <a href="#">Notes 3, 4</a> )..... | 35                   | 8                         |
| Maximum Storage Temperature Range .....            | -65°C to +150°C      |                           |
| Maximum Junction Temperature ( $T_{JMAX}$ ) .....  |                      | +150°C                    |
| Pb-Free Reflow Profile .....                       |                      | see <a href="#">TB493</a> |

**Recommended Operating Conditions**

|  |                         |
|--|-------------------------|
| Ambient Operating Temperature Range .....    | -55°C to +125°C         |
| Maximum Operating Junction Temperature ..... | +150°C                  |
| Supply Voltage .....                         | 10V (±5V) to 30V (±15V) |

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| PARAMETER    | DESCRIPTION              | TEST CONDITIONS             | MIN<br>(Note 5)              | TYP    | MAX<br>(Note 5)            | UNITS |
|--------------|--------------------------|-----------------------------|------------------------------|--------|----------------------------|-------|
| $V_{OL}$     | Output Voltage Low       | $R_L = 10k\Omega$ to ground |                              | -13.7  | -13.5                      | V     |
|              |                          |                             |                              |        | <b>-13.2</b>               | V     |
|              | Supply Current/Amplifier | $R_L = 2k\Omega$ to ground  |                              | -13.55 | -13.3                      | V     |
|              |                          |                             |                              |        | <b>-13.0</b>               | V     |
| $I_S$        | Supply Current/Amplifier |                             |                              | 0.44   | 0.625                      | mA    |
|              |                          |                             |                              |        | <b>0.75</b>                | mA    |
| $I_{SC}$     | Short-Circuit Current    |                             |                              | 43     |                            | mA    |
| $V_{SUPPLY}$ | Supply Voltage Range     | guaranteed by PSRR          | <b><math>\pm 2.25</math></b> |        | <b><math>\pm 20</math></b> | V     |

## AC SPECIFICATIONS

|             |                           |  |  |        |  |                |
|-------------|---------------------------|--|--|--------|--|----------------|
| GBWP        | Gain Bandwidth Product    | $A_V = 1k$ , $R_L = 2k\Omega$                          |  | 1.5    |  | MHz            |
| $e_{nVp-p}$ | Voltage Noise $V_{P-P}$   | 0.1Hz to 10Hz  |  | 0.25   |  | $\mu V_{P-P}$  |
| $e_n$       | Voltage Noise Density     | $f = 10Hz$   |  | 10     |  | $nV/\sqrt{Hz}$ |
| $e_n$       | Voltage Noise Density     | $f = 100Hz$  |  | 8.2    |  | $nV/\sqrt{Hz}$ |
| $e_n$       | Voltage Noise Density     | $f = 1kHz$   |  | 8      |  | $nV/\sqrt{Hz}$ |
| $e_n$       | Voltage Noise Density     | $f = 10kHz$  |  | 8      |  | $nV/\sqrt{Hz}$ |
| $i_n$       | Current Noise Density     | $f = 1kHz$   |  | 0.1    |  | $pA/\sqrt{Hz}$ |
| THD + N     | Total Harmonic Distortion | 1kHz, $G = 1$ , $V_O = 3.5V_{RMS}$ , $R_L = 2k\Omega$  |  | 0.0009 |  | %              |
|             |                           | 1kHz, $G = 1$ , $V_O = 3.5V_{RMS}$ , $R_L = 10k\Omega$ |  | 0.0005 |  | %              |

## TRANSIENT RESPONSE

|                                 |  |   |            |      |            |            |
|---------------------------------|--|---|------------|------|------------|------------|
| SR                              | Slew Rate, $V_{OUT}$ 20% to 80%                      | $A_V = 11$ , $R_L = 2k\Omega$ , $V_O = 4V_{P-P}$                                    | 0.3        | 0.5  |            | V/ $\mu$ s |
|                                 |  |   | <b>0.2</b> |      |            | V/ $\mu$ s |
| $t_r$ , $t_f$ ,<br>Small Signal | Rise Time<br>10% to 90% of $V_{OUT}$                 | $A_V = 1$ , $V_{OUT} = 50mV_{P-P}$ ,<br>$R_L = 10k\Omega$ to $V_{CM}$               |            | 130  | 450        | ns         |
|                                 |  |   |            |      | <b>625</b> | ns         |
|                                 | Fall Time<br>90% to 10% of $V_{OUT}$                 | $A_V = 1$ , $V_{OUT} = 50mV_{P-P}$ , $R_L = 10k\Omega$ to $V_{CM}$                  |            | 130  | 600        | ns         |
|                                 |  |   |            |      | <b>700</b> | ns         |
| $t_s$                           | Settling Time to 0.1%<br>10V Step; 10% to $V_{OUT}$  | $A_V = -1$ , $V_{OUT} = 10V_{P-P}$ , $R_L = 5k\Omega$ to $V_{CM}$                   |            | 21   |            | $\mu$ s    |
|                                 | Settling Time to 0.01%<br>10V Step; 10% to $V_{OUT}$ | $A_V = -1$ , $V_{OUT} = 10V_{P-P}$ , $R_L = 5k\Omega$ to $V_{CM}$                   |            | 24   |            | $\mu$ s    |
|                                 | Settling Time to 0.1%<br>4V Step; 10% to $V_{OUT}$   | $A_V = -1$ , $V_{OUT} = 4V_{P-P}$ , $R_L = 5k\Omega$ to $V_{CM}$                    |            | 13   |            | $\mu$ s    |
|                                 | Settling Time to 0.01%<br>4V Step; 10% to $V_{OUT}$  | $A_V = -1$ , $V_{OUT} = 4V_{P-P}$ , $R_L = 5k\Omega$ to $V_{CM}$                    |            | 18   |            | $\mu$ s    |
| $t_{OL}$                        | Output Positive Overload Recovery Time               | $A_V = -100$ , $V_{IN} = 0.2V_{P-P}$ , $R_L = 2k\Omega$ to $V_{CM}$                 |            | 5.6  |            | $\mu$ s    |
|                                 | Output Negative Overload Recovery Time               | $A_V = -100$ , $V_{IN} = 0.2V_{P-P}$ , $R_L = 2k\Omega$ to $V_{CM}$                 |            | 10.6 |            | $\mu$ s    |
| OS+                             | Positive Overshoot                                   | $A_V = 1$ , $V_{OUT} = 10V_{P-P}$ , $R_f = 0\Omega$<br>$R_L = 2k\Omega$ to $V_{CM}$ |            | 15   |            | %          |
|                                 |  |   |            |      | <b>33</b>  | %          |
| OS-                             | Negative Overshoot                                   | $A_V = 1$ , $V_{OUT} = 10V_{P-P}$ , $R_f = 0\Omega$<br>$R_L = 2k\Omega$ to $V_{CM}$ |            | 15   |            | %          |
|                                 |  |   |            |      | <b>33</b>  | %          |

# ISL70419SEH

**Electrical Specifications**  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $V_O = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted. **Boldface** limits apply over the operating temperature range,  $-55^\circ C$  to  $+125^\circ C$ ; over a total ionizing dose of 300krad(SI) with exposure at a high dose rate of 50 - 300krad(SI)/s; or over a total ionizing dose of 50krad(SI) with exposure at a low dose rate of <10mrad(SI)/s.

| PARAMETER                | DESCRIPTION                                  | CONDITIONS  | MIN<br>(Note 5) | TYP         | MAX<br>(Note 5) | UNIT             |
|--------------------------|--|---|-----------------|-------------|-----------------|------------------|
| $V_{OS}$                 | Input Offset Voltage                         |   |                 | 10          | 150             | $\mu V$          |
|                          |  |   |                 |             | <b>250</b>      | $\mu V$          |
| $TCV_{OS}$               | Offset Voltage Drift                         | guaranteed by characterization not tested               |                 | 0.1         | <b>1</b>        | $\mu V/^\circ C$ |
| $I_B$                    | Input Bias Current                           |   | -2.5            | 0.08        | 2.5             | nA               |
|                          |  | $T_A = -55^\circ C$ to $+125^\circ C$                   | -5              |             | 5               | nA               |
|                          |  | over high and low dose radiation                        | -15             |             | 15              | nA               |
| $TCI_B$                  | Input Bias Current Temperature Coefficient   | guaranteed by characterization not tested               | -5              | <b>1</b>    | <b>5</b>        | $pA/^\circ C$    |
| $I_{OS}$                 | Input Offset Current                         |   | -2.5            | 0.08        | 2.5             | nA               |
|                          |  | $T_A = -55^\circ C$ to $+125^\circ C$                   | -3              |             | 3               | nA               |
|                          |  | over high and low dose radiation                        | -10             |             | 10              | nA               |
| $TCI_{OS}$               | Input Offset Current Temperature Coefficient | guaranteed by characterization not tested               | -3              | <b>0.42</b> | <b>3</b>        | $pA/^\circ C$    |
| $V_{CM}$                 | Input Voltage Range                          | guaranteed by CMRR test                                 | <b>-3</b>       |             | <b>3</b>        | V                |
| $CMRR$                   | Common-Mode Rejection Ratio                  | $V_{CM} = -3V$ to $+3V$                                 | 120             | 145         |                 | dB               |
|                          |  |   | <b>120</b>      |             |                 | dB               |
| $PSRR$                   | Power Supply Rejection Ratio                 | $V_S = \pm 2.25V$ to $\pm 5V$                           | 120             | 145         |                 | dB               |
|                          |  |   | <b>120</b>      |             |                 | dB               |
| $A_{VOL}$                | Open-Loop Gain                               | $V_O = -3.0V$ to $+3.0V$<br>$R_L = 10k\Omega$ to ground | 3,000           | 14,000      |                 | V/mV             |
| $V_{OH}$                 | Output Voltage High                          | $R_L = 10k\Omega$ to ground                             | 3.5             | 3.7         |                 | V                |
|                          |  |   | <b>3.2</b>      |             |                 | V                |
|                          |  | $R_L = 2k\Omega$ to ground                              | 3.3             | 3.55        |                 | V                |
|                          |  |   | <b>3.0</b>      |             |                 | V                |
| $V_{OL}$                 | Output Voltage Low                           | $R_L = 10k\Omega$ to ground                             |                 | -3.7        | -3.5            | V                |
|                          |  |   |                 |             | <b>-3.2</b>     | V                |
|                          |  | $R_L = 2k\Omega$ to ground                              |                 | -3.55       | -3.3            | V                |
|                          |  |   |                 |             | <b>-3.0</b>     | V                |
| $I_S$                    | Supply Current/Amplifier                     |   |                 | 0.44        | 0.625           | mA               |
|                          |  |   |                 |             | <b>0.75</b>     | mA               |
| $I_{SC}$                 | Short-Circuit Current                        |   |                 | 43          |                 | mA               |
| <b>AC SPECIFICATIONS</b> |  |   |                 |             |                 |                  |
| $GBWP$                   | Gain Bandwidth Product                       | $A_V = 1k$ , $R_L = 2k\Omega$                           |                 | 1.5         |                 | MHz              |
| $e_{np-p}$               | Voltage Noise                                | 0.1Hz to 10Hz   |                 | 0.25        |                 | $\mu V_{P-P}$    |
| $e_n$                    | Voltage Noise Density                        | $f = 10Hz$  |                 | <b>12</b>   |                 | $nV/\sqrt{Hz}$   |
| $e_n$                    | Voltage Noise Density                        | $f = 100Hz$   |                 | <b>8.6</b>  |                 | $nV/\sqrt{Hz}$   |
| $e_n$                    | Voltage Noise Density                        | $f = 1kHz$  |                 | <b>8</b>    |                 | $nV/\sqrt{Hz}$   |
| $e_n$                    | Voltage Noise Density                        | $f = 10kHz$   |                 | <b>8</b>    |                 | $nV/\sqrt{Hz}$   |
| $i_n$                    | Current Noise Density                        | $f = 1kHz$  |                 | 0.1         |                 | $pA/\sqrt{Hz}$   |

# ISL70419SEH

**Electrical Specifications**  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $V_O = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted. **Boldface limits apply over the operating temperature range,  $-55^\circ C$  to  $+125^\circ C$ ; over a total ionizing dose of 300krad(SI) with exposure at a high dose rate of 50 - 300krad(SI)/s; or over a total ionizing dose of 50krad(SI) with exposure at a low dose rate of <10mrad(SI)/s.** (Continued)

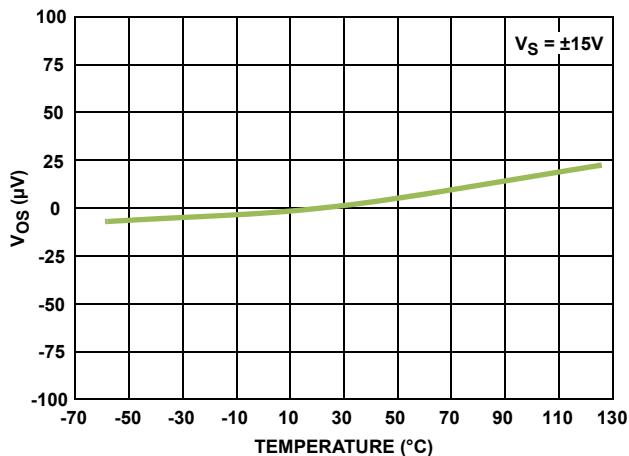
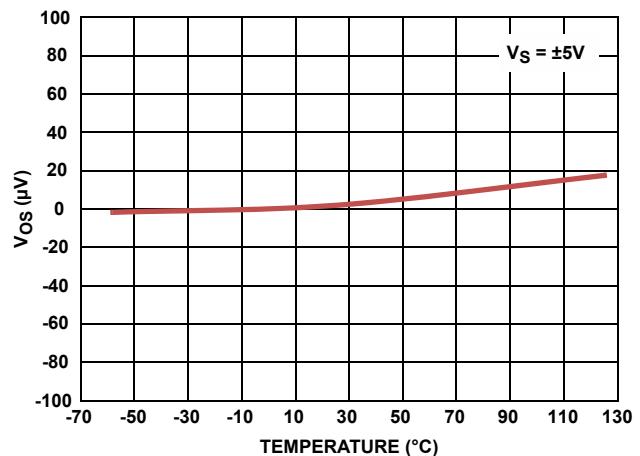
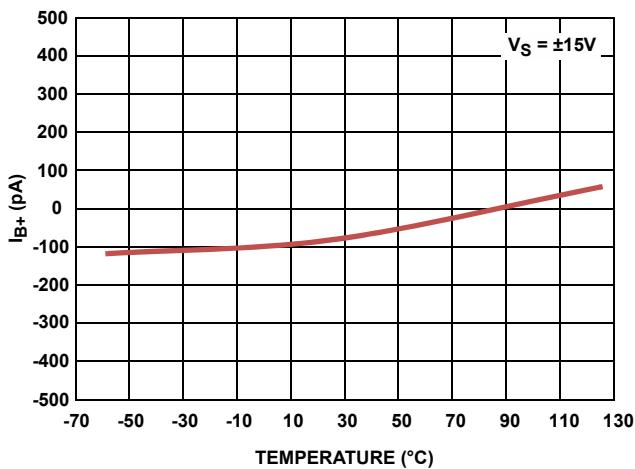
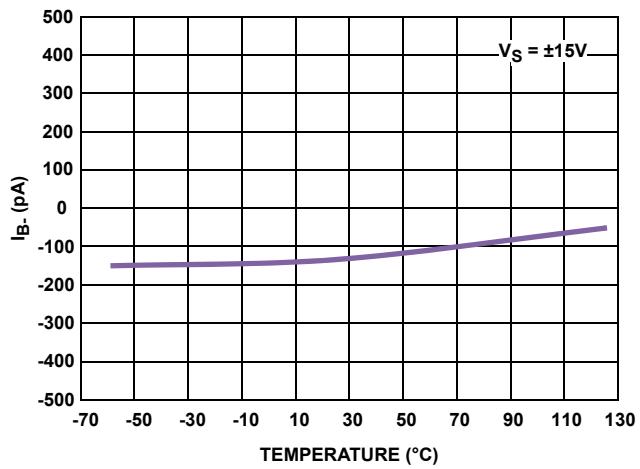
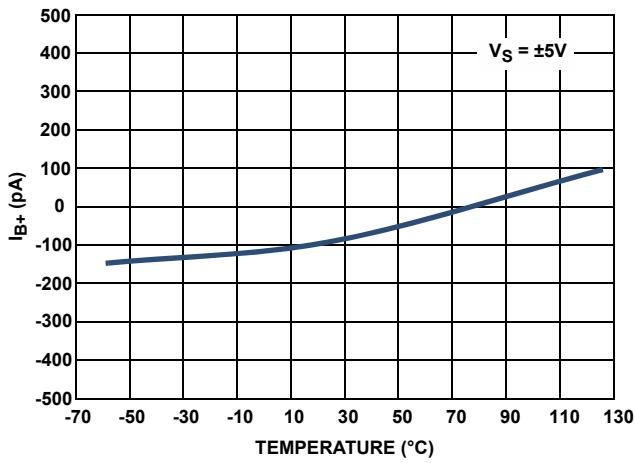
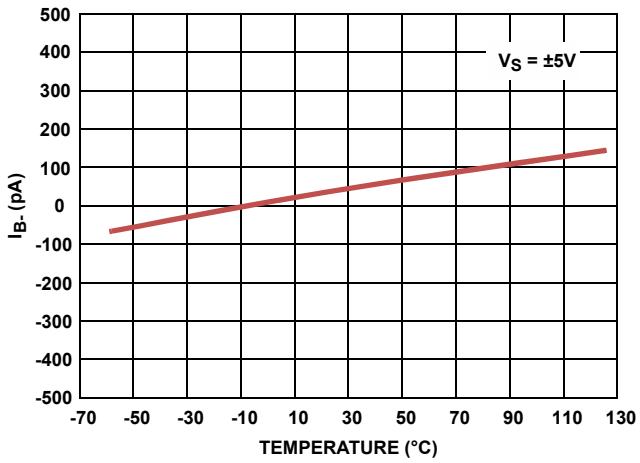
| PARAMETER                       | DESCRIPTION   | CONDITIONS  | MIN<br><b>(Note 5)</b> | TYP | MAX<br><b>(Note 5)</b> | UNIT      |
|---------------------------------|---|---|------------------------|-----|------------------------|-----------|
| <b>TRANSIENT RESPONSE</b>       |   |   |                        |     |                        |           |
| SR                              | Slew Rate, $V_{OUT}$ 20% to 80%                     | $A_V = 11$ , $R_L = 2k\Omega$ , $V_O = 4V_{P-P}$                                      |                        | 0.5 |                        | $V/\mu s$ |
| $t_r$ , $t_f$ ,<br>Small Signal | Rise Time<br>10% to 90% of $V_{OUT}$                | $A_V = 1$ , $V_{OUT} = 50mV_{P-P}$ ,<br>$R_L = 10k\Omega$ to $V_{CM}$                 |                        | 130 |                        | ns        |
|                                 | Fall Time<br>90% to 10% of $V_{OUT}$                | $A_V = 1$ , $V_{OUT} = 50mV_{P-P}$ ,<br>$R_L = 10k\Omega$ to $V_{CM}$                 |                        | 130 |                        | ns        |
| $t_s$                           | Settling Time to 0.1%<br>4V Step; 10% to $V_{OUT}$  | $A_V = -1$ , $V_{OUT} = 4V_{P-P}$ ,<br>$R_L = 5k\Omega$ to $V_{CM}$                   |                        | 12  |                        | $\mu s$   |
|                                 | Settling Time to 0.01%<br>4V Step; 10% to $V_{OUT}$ | $A_V = -1$ , $V_{OUT} = 4V_{P-P}$ ,<br>$R_L = 5k\Omega$ to $V_{CM}$                   |                        | 19  |                        | $\mu s$   |
| $t_{OL}$                        | Output Positive Overload Recovery Time              | $A_V = -100$ , $V_{IN} = 0.2V_{P-P}$ ,<br>$R_L = 2k\Omega$ to $V_{CM}$                |                        | 7   |                        | $\mu s$   |
|                                 | Output Negative Overload Recovery Time              | $A_V = -100$ , $V_{IN} = 0.2V_{P-P}$ ,<br>$R_L = 2k\Omega$ to $V_{CM}$                |                        | 5.8 |                        | $\mu s$   |
| OS+                             | Positive Overshoot                                  | $A_V = 1$ , $V_{OUT} = 10V_{P-P}$ , $R_f = 0\Omega$ ,<br>$R_L = 2k\Omega$ to $V_{CM}$ |                        | 15  |                        | %         |
| OS-                             | Negative Overshoot                                  | $A_V = 1$ , $V_{OUT} = 10V_{P-P}$ , $R_f = 0\Omega$ ,<br>$R_L = 2k\Omega$ to $V_{CM}$ |                        | 15  |                        | %         |

**NOTE:**

5. Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ\text{C}$ , unless otherwise specified.

FIGURE 3.  $V_{OS}$  vs TEMPERATUREFIGURE 4.  $V_{OS}$  vs TEMPERATUREFIGURE 5.  $I_{B+}$  vs TEMPERATUREFIGURE 6.  $I_{B-}$  vs TEMPERATUREFIGURE 7.  $I_{B+}$  vs TEMPERATUREFIGURE 8.  $I_{B-}$  vs TEMPERATURE

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ\text{C}$ , unless otherwise specified. (Continued)

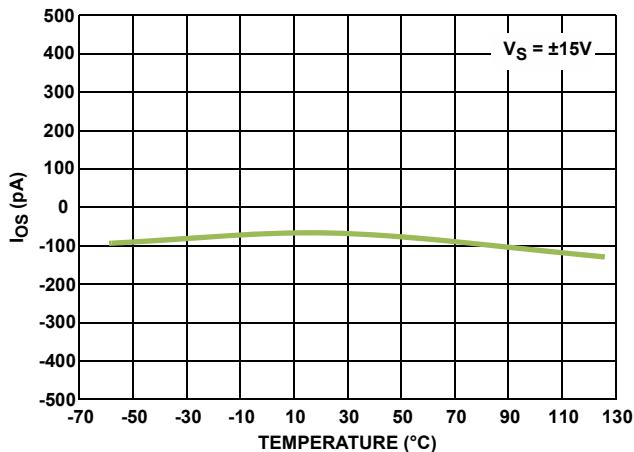


FIGURE 9.  $I_{OS}$  vs TEMPERATURE

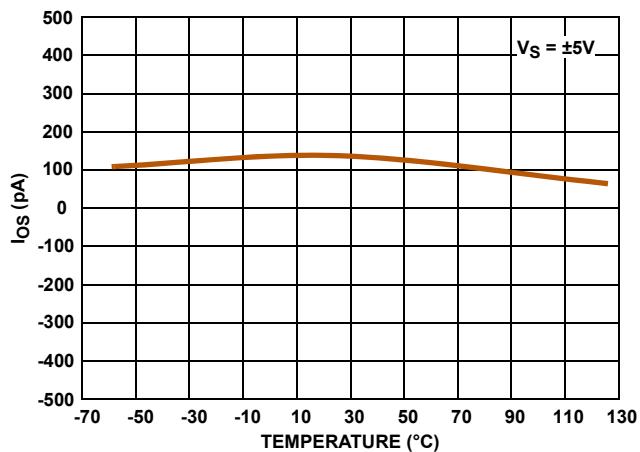


FIGURE 10.  $I_{OS}$  vs TEMPERATURE

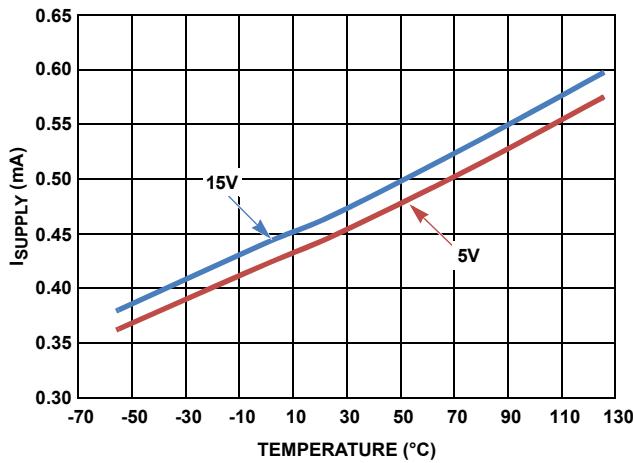


FIGURE 11. SUPPLY CURRENT PER AMP vs TEMPERATURE

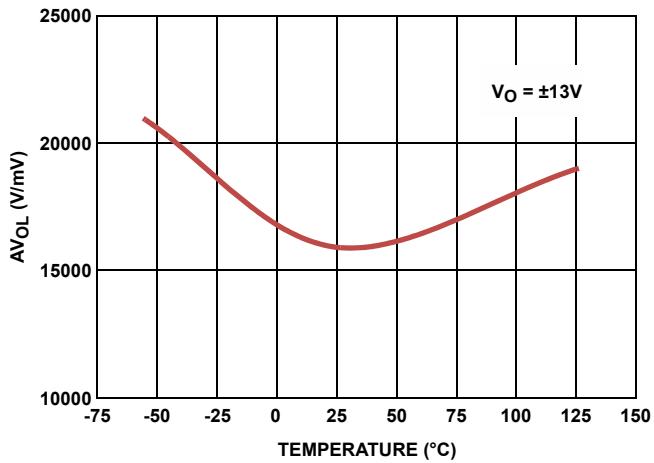


FIGURE 12.  $A_{VOL}$  vs TEMPERATURE

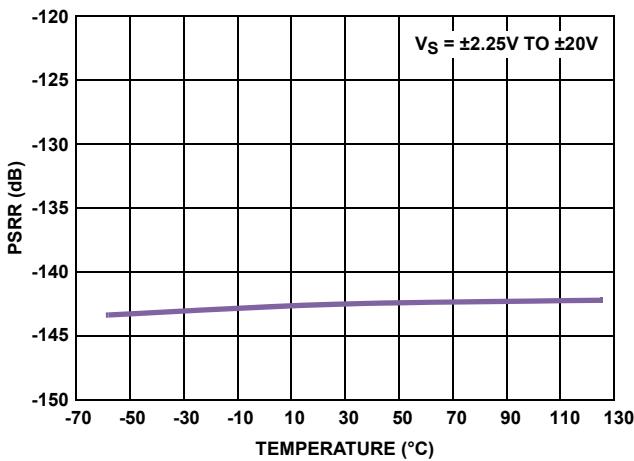


FIGURE 13. PSRR vs TEMPERATURE

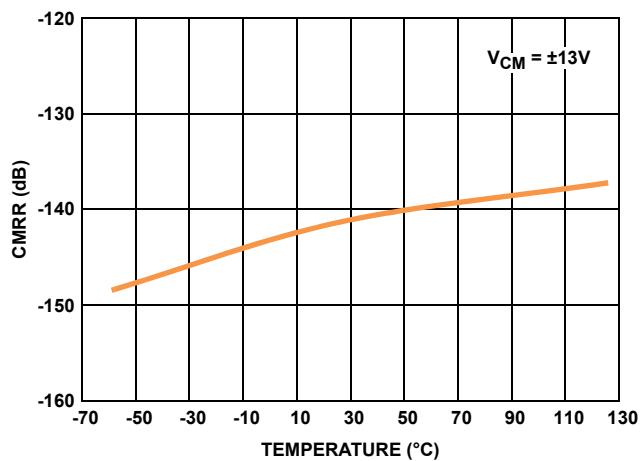


FIGURE 14. CMRR vs TEMPERATURE

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ C$ , unless otherwise specified. (Continued)

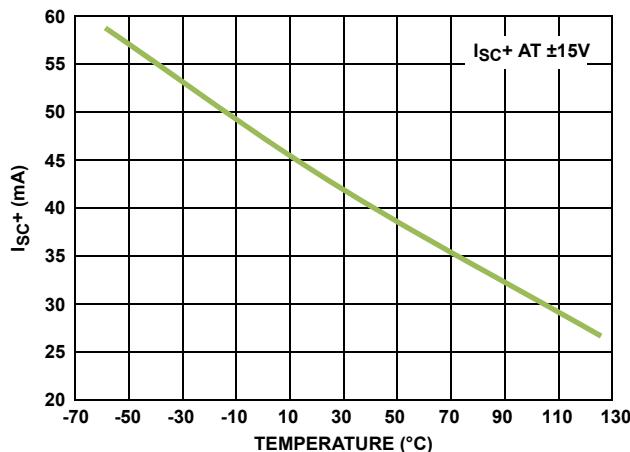


FIGURE 15. SHORT CIRCUIT CURRENT vs TEMPERATURE

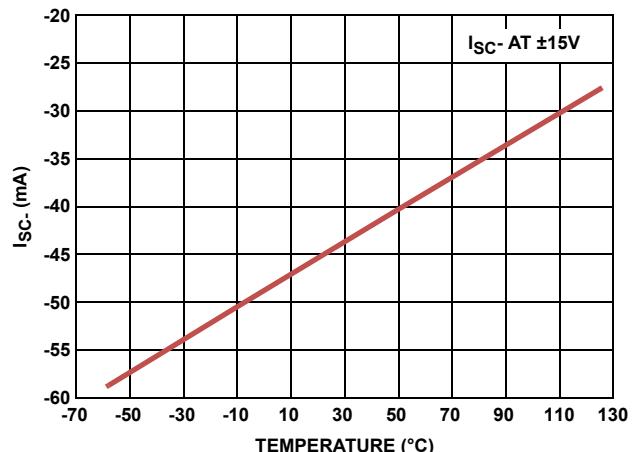


FIGURE 16. SHORT CIRCUIT CURRENT vs TEMPERATURE

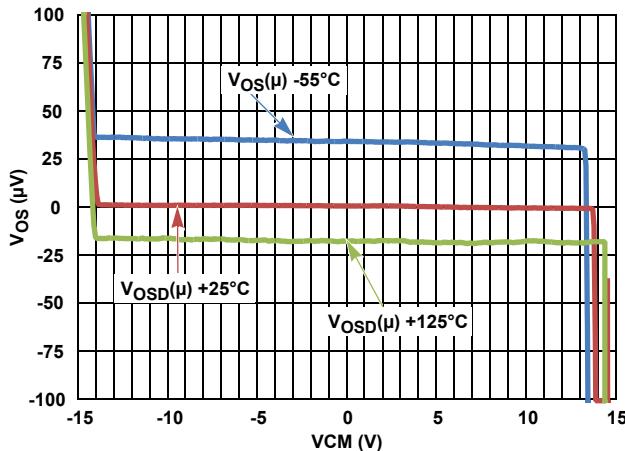


FIGURE 17. INPUT  $V_{OS}$  vs INPUT COMMON MODE VOLTAGE,  
 $V_S = \pm 15V$

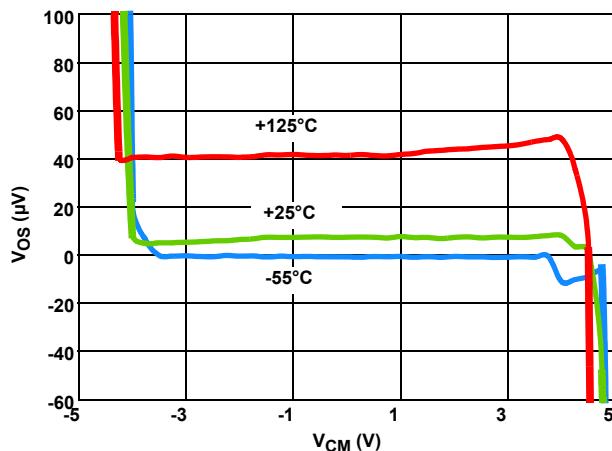


FIGURE 18. INPUT  $V_{OS}$  vs INPUT COMMON MODE VOLTAGE,  
 $V_S = \pm 5V$

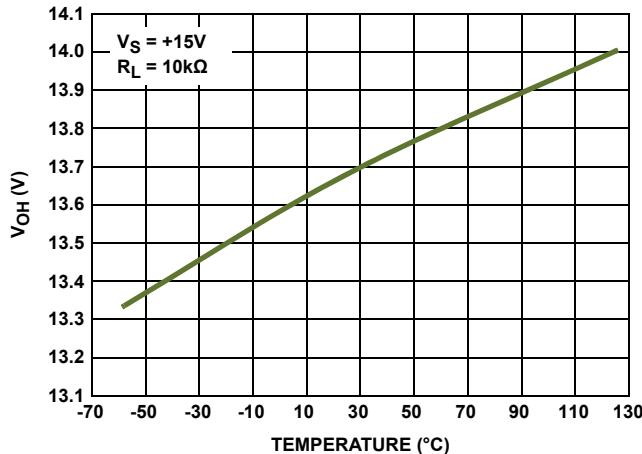


FIGURE 19.  $V_{OUT}$  vs TEMPERATURE

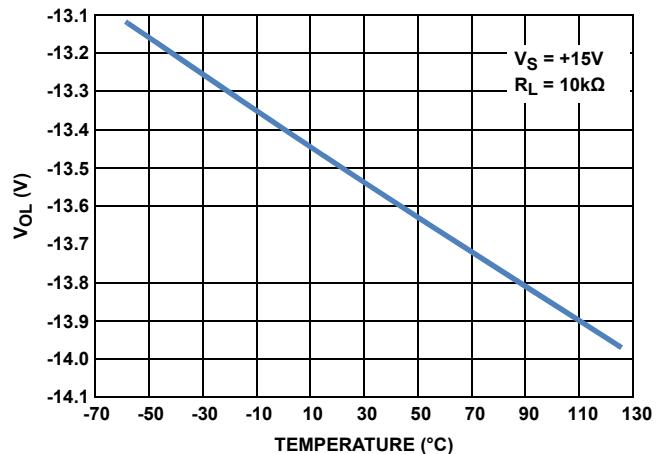


FIGURE 20.  $V_{OUT}$  vs TEMPERATURE

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ\text{C}$ , unless otherwise specified. (Continued)

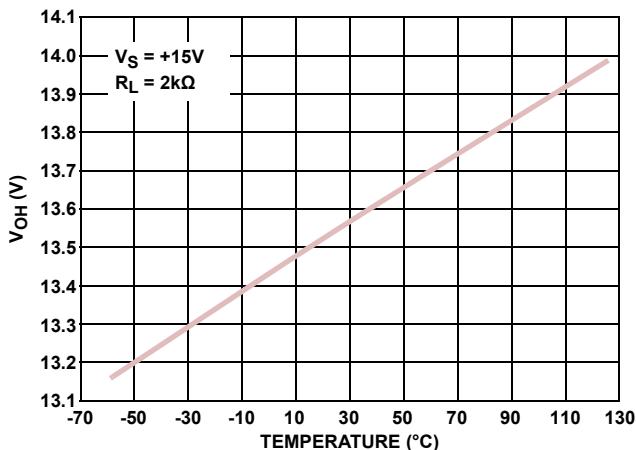


FIGURE 21.  $V_{OUT}$  vs TEMPERATURE

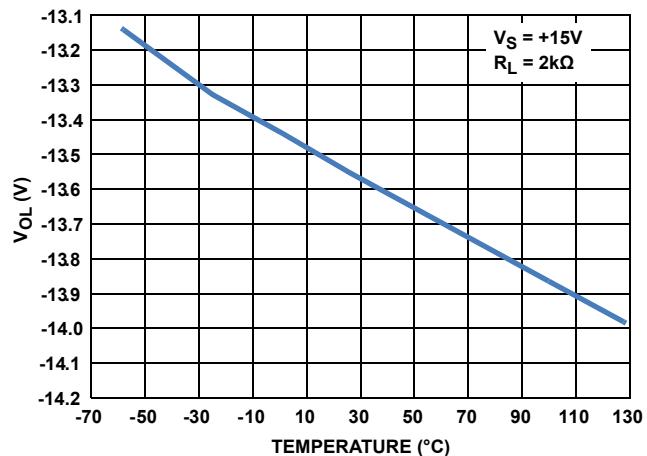


FIGURE 22.  $V_{OUT}$  vs TEMPERATURE

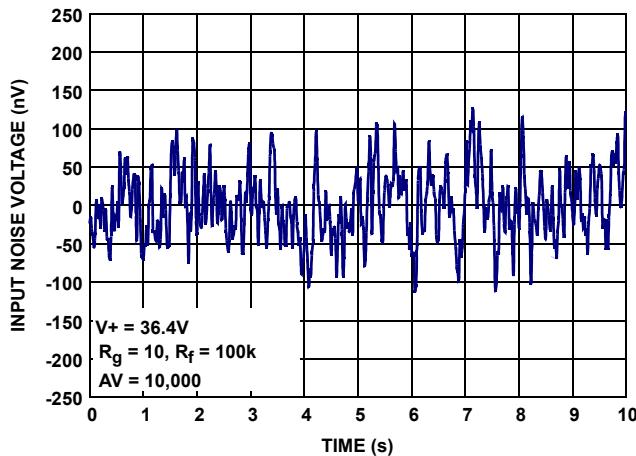


FIGURE 23. INPUT NOISE VOLTAGE 0.1Hz to 10Hz

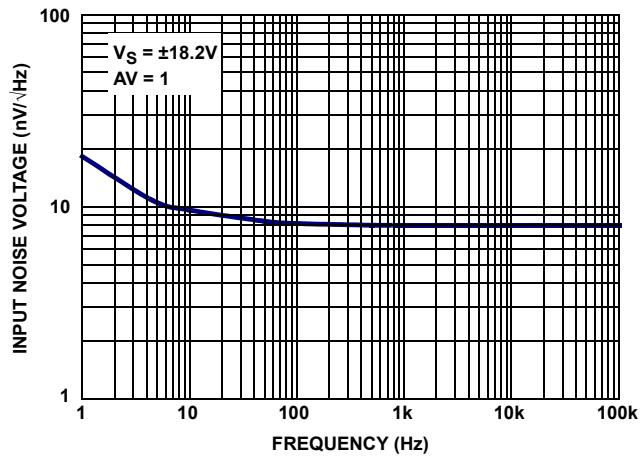


FIGURE 24. INPUT NOISE VOLTAGE SPECTRAL DENSITY

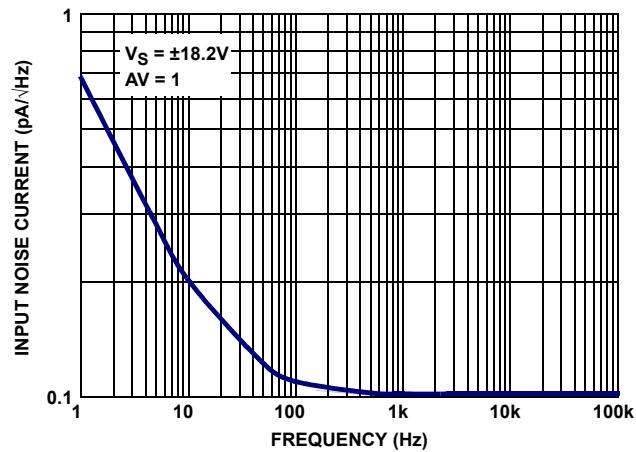


FIGURE 25. INPUT NOISE CURRENT SPECTRAL DENSITY

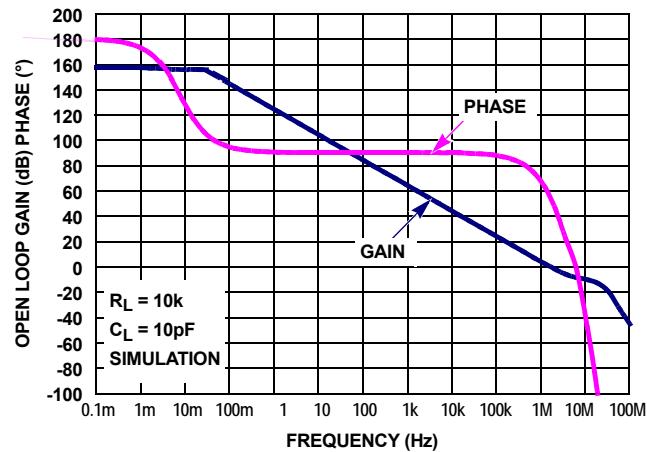


FIGURE 26. OPEN-LOOP GAIN, PHASE vs FREQUENCY,  $R_L = 10k\Omega$ ,  $C_L = 10pF$

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ C$ , unless otherwise specified. (Continued)

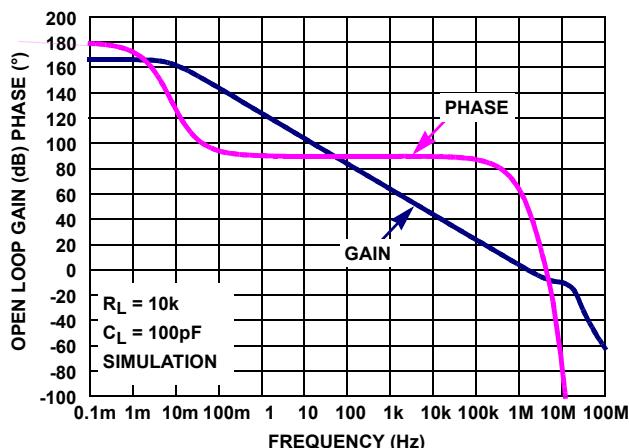


FIGURE 27. OPEN-LOOP GAIN, PHASE vs FREQUENCY,  $R_L = 10k\Omega$ ,  $C_L = 100pF$

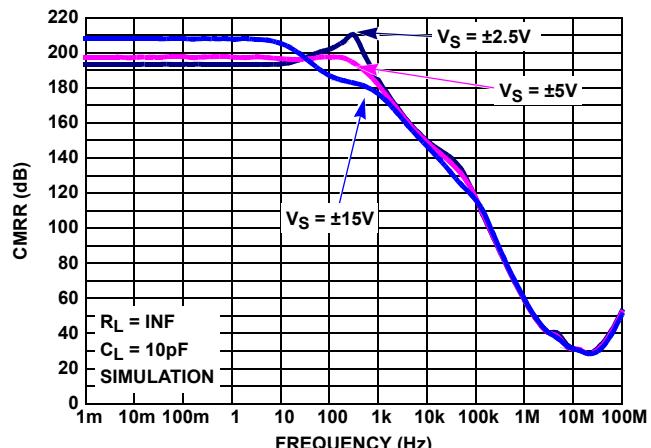


FIGURE 28. CMRR vs FREQUENCY,  $V_S = \pm 2.25, \pm 5V, \pm 15V$

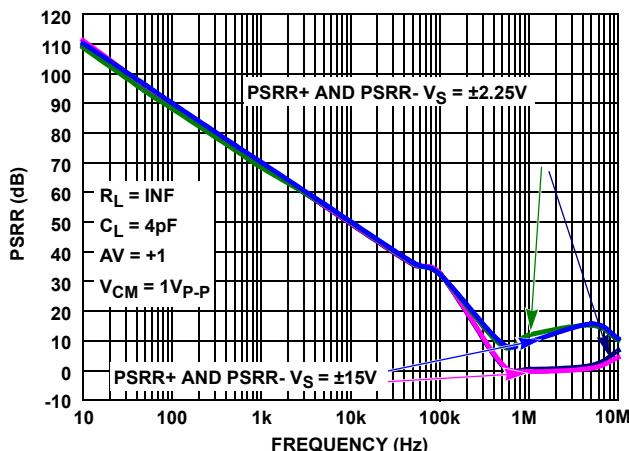


FIGURE 29. PSRR vs FREQUENCY,  $V_S = \pm 5V, \pm 15V$

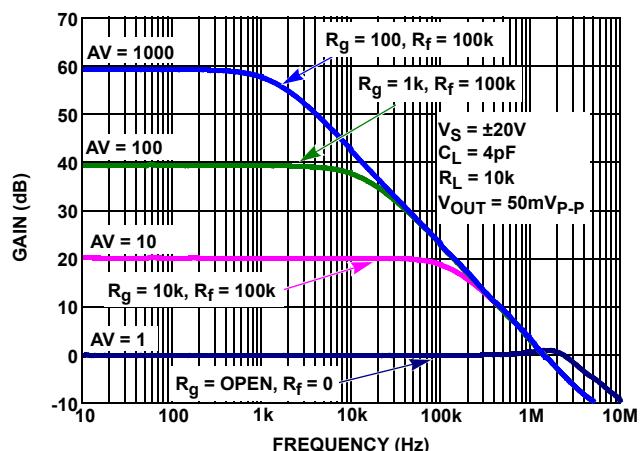


FIGURE 30. FREQUENCY RESPONSE vs CLOSED LOOP GAIN

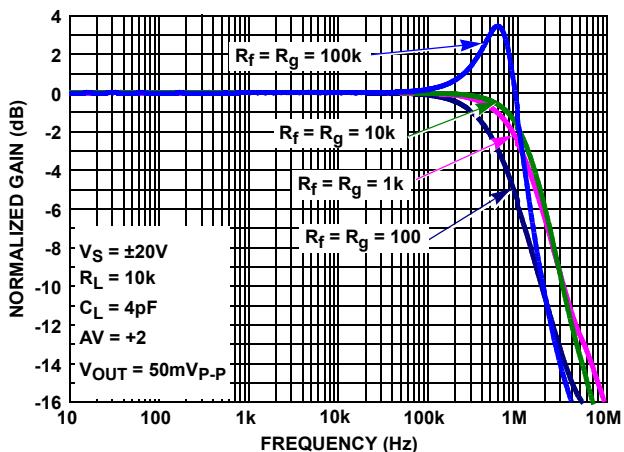


FIGURE 31. FREQUENCY RESPONSE vs FEEDBACK RESISTANCE  $R_f/R_g$

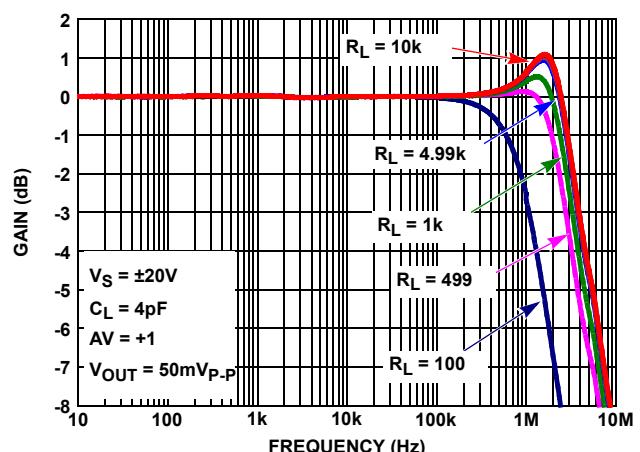


FIGURE 32. GAIN vs FREQUENCY vs  $R_L$

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ C$ , unless otherwise specified. (Continued)

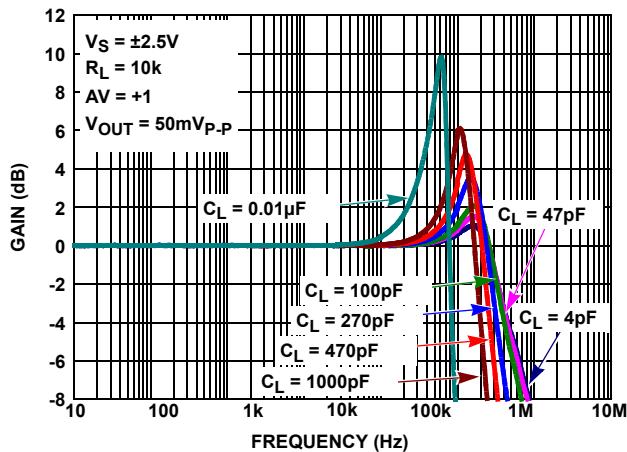


FIGURE 33. GAIN vs FREQUENCY vs  $C_L$

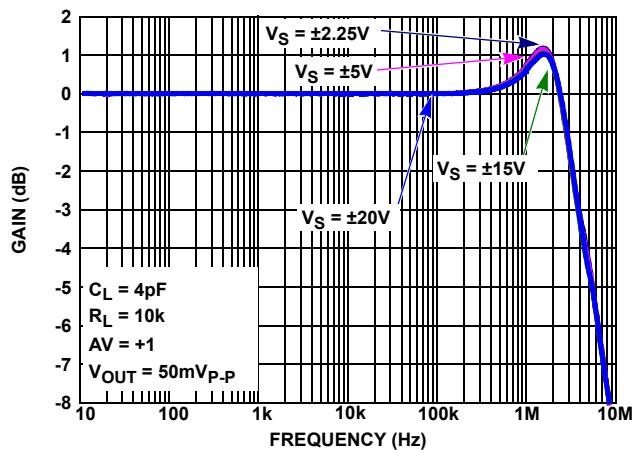


FIGURE 34. GAIN vs FREQUENCY vs SUPPLY VOLTAGE

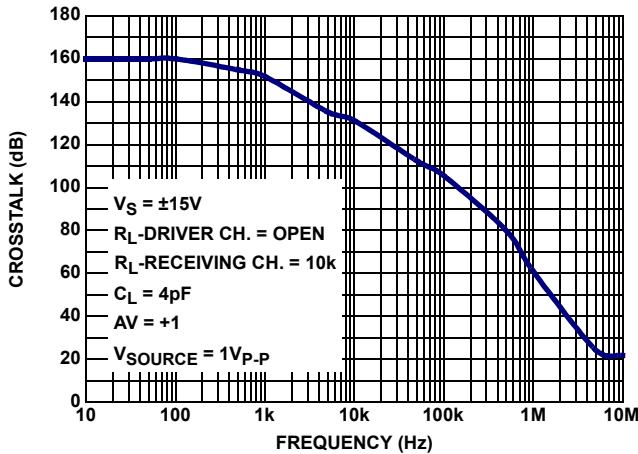


FIGURE 35. CROSSTALK,  $V_S = \pm 15V$

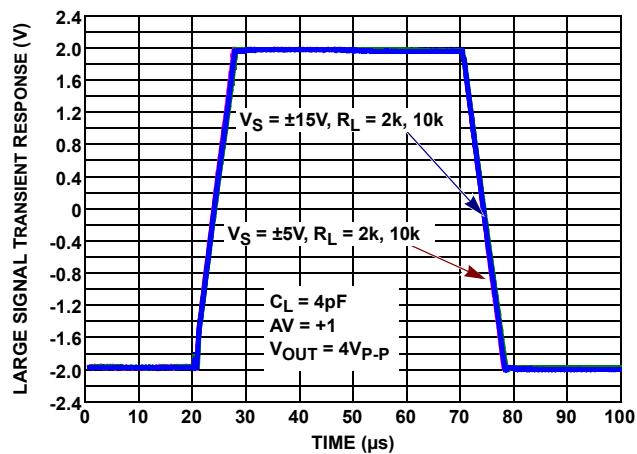


FIGURE 36. LARGE SIGNAL TRANSIENT RESPONSE vs  $R_L$   $V_S = \pm 5V$ ,  $\pm 15V$

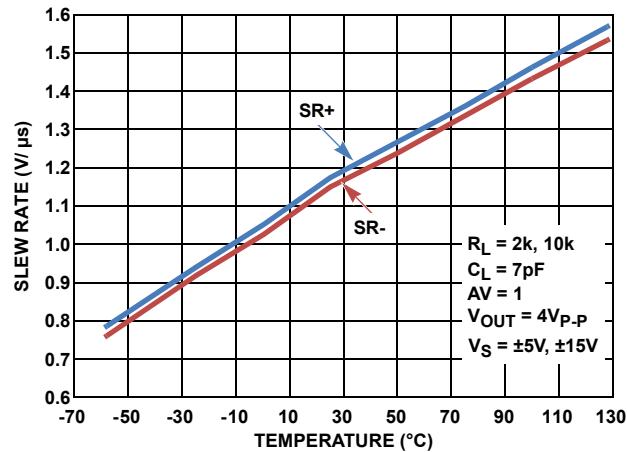


FIGURE 37. SLEW RATE vs TEMPERATURE  $V_S = \pm 5V, \pm 15V$

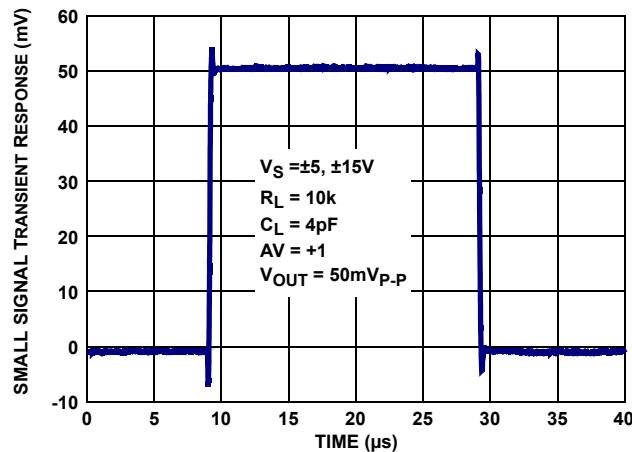


FIGURE 38. SMALL SIGNAL TRANSIENT RESPONSE,  $V_S = \pm 5V, \pm 15V$

## Typical Performance Curves

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $R_L = \text{Open}$ ,  $T_A = +25^\circ C$ , unless otherwise specified. (Continued)

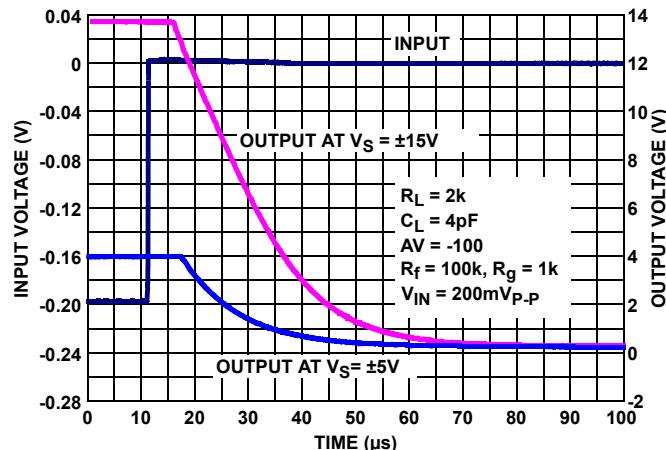


FIGURE 39. POSITIVE OUTPUT OVERLOAD RESPONSE TIME,  
 $V_S = \pm 5V, \pm 15V$

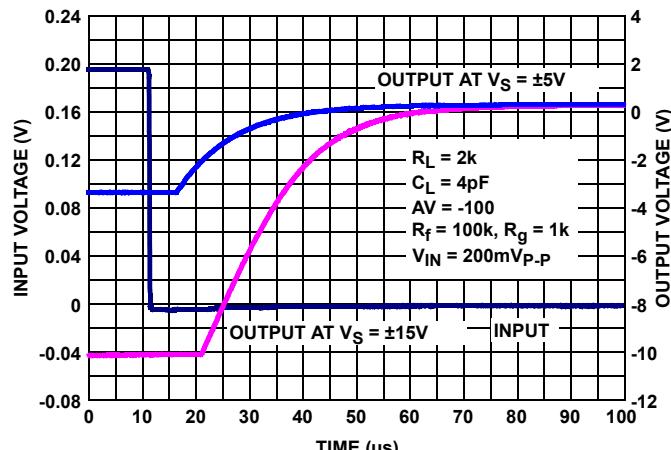


FIGURE 40. NEGATIVE OUTPUT OVERLOAD RESPONSE TIME,  
 $V_S = \pm 5V, \pm 15V$

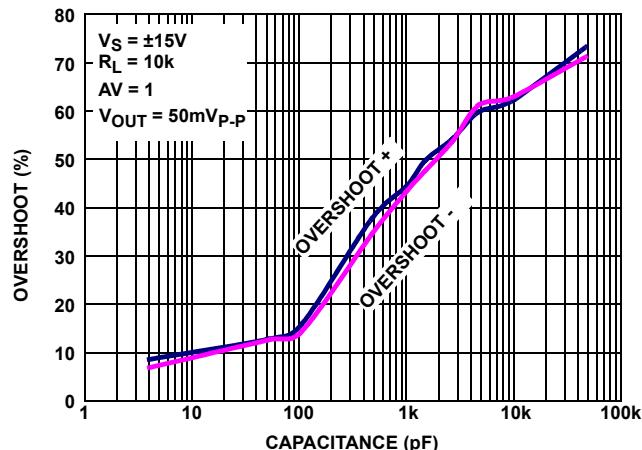


FIGURE 41. % OVERSHOOT vs LOAD CAPACITANCE,  $V_S = \pm 15V$

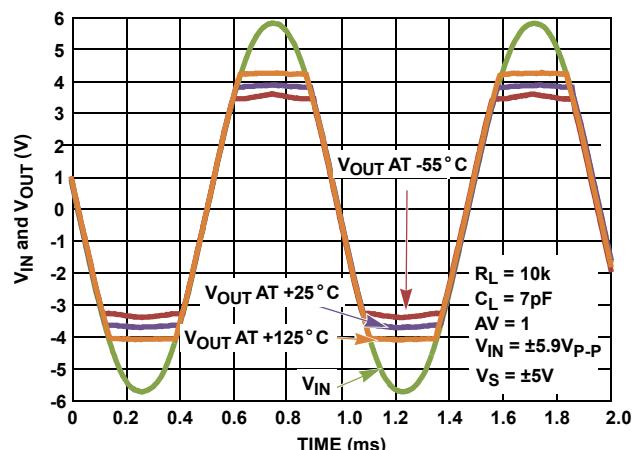


FIGURE 42. OUTPUT PHASE REVERSAL RESPONSE vs TEMPERATURE

**Post High Dose Radiation Characteristics** Unless otherwise specified,  $V_S \pm 15V$ ,  $V_{CM} = 0$ ,  $V_O = 0V$ ,  $T_A = +25^\circ C$ . This data is typical mean test data post radiation exposure at a high dose rate of 50 - 300rad(Si)/s. This data is intended to show typical parameter shifts due to high dose rate radiation. These are not limits nor are they guaranteed.

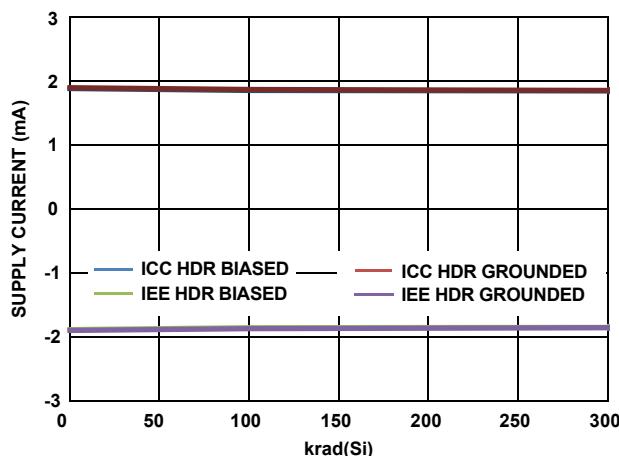


FIGURE 43. SUPPLY CURRENT vs HIGH DOSE RATE RADIATION

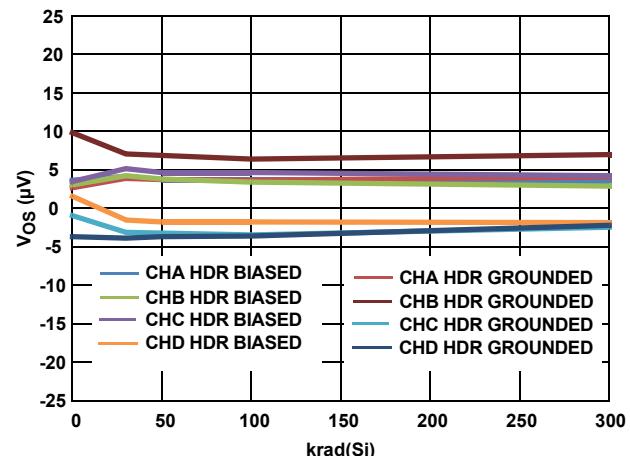


FIGURE 44.  $V_{OS}$  vs HIGH DOSE RATE RADIATION

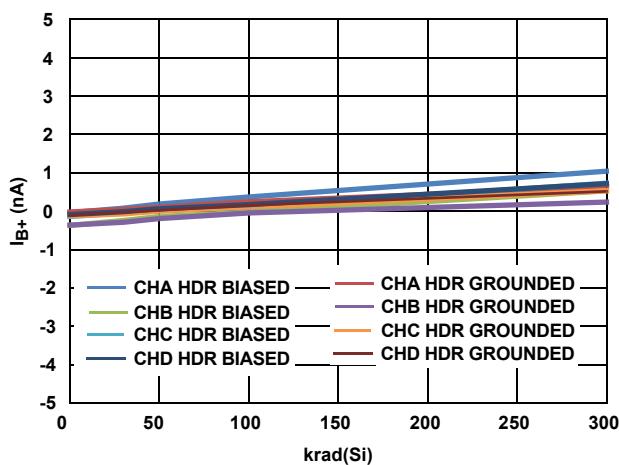


FIGURE 45.  $I_{B^+}$  vs HIGH DOSE RATE RADIATION

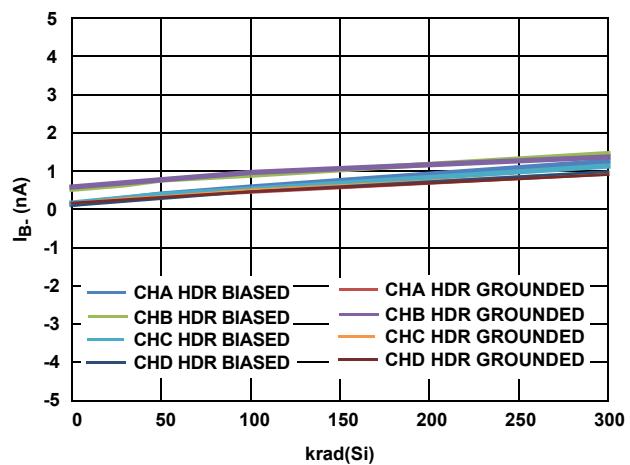


FIGURE 46.  $I_{B^-}$  vs HIGH DOSE RATE RADIATION

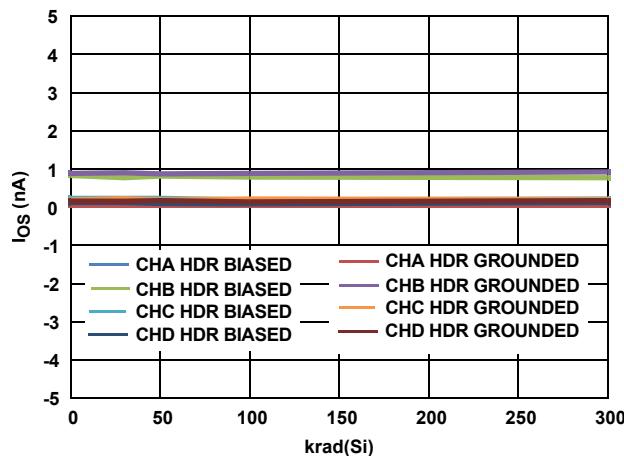


FIGURE 47.  $I_{OS}$  vs HIGH DOSE RATE RADIATION

**Post Low Dose Radiation Characteristics** Unless otherwise specified,  $V_S \pm 15V$ ,  $V_{CM} = 0$ ,  $V_O = 0V$ ,  $T_A = +25^\circ C$ . This data is typical mean test data post radiation exposure at a low dose rate of <10Mrad(Si)/s. This data is intended to show typical parameter shifts due to low dose rate radiation. These are not limits nor are they guaranteed

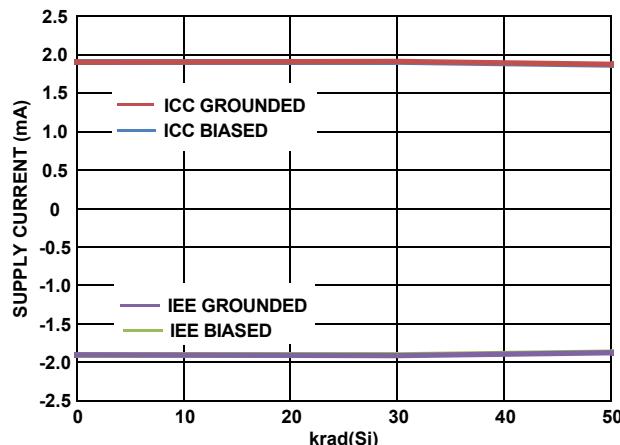


FIGURE 48. SUPPLY CURRENT vs LOW DOSE RATE RADIATION

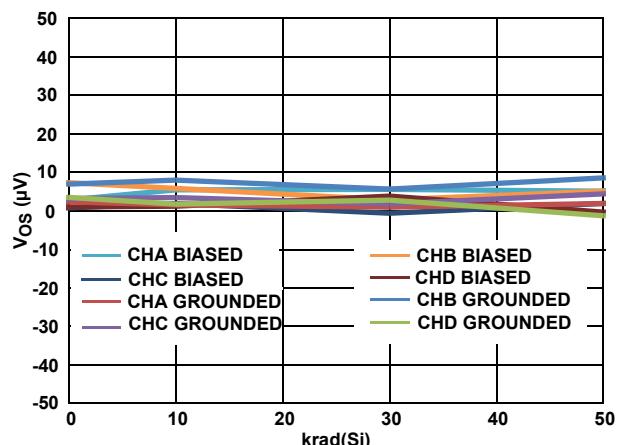


FIGURE 49.  $V_{OS}$  vs LOW DOSE RATE RADIATION

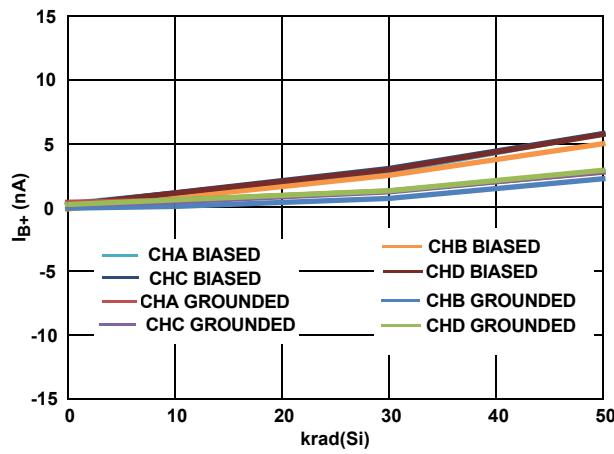


FIGURE 50.  $I_{B^+}$  vs LOW DOSE RATE RADIATION

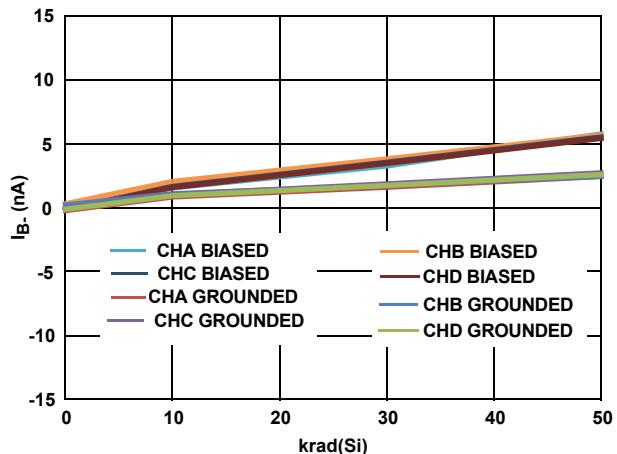


FIGURE 51.  $I_{B^-}$  vs LOW DOSE RATE RADIATION

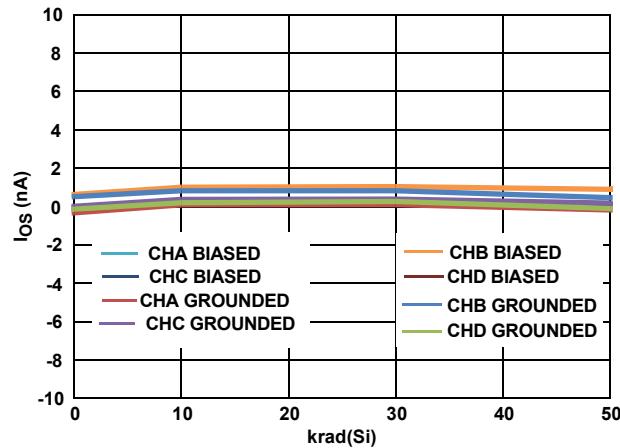


FIGURE 52.  $I_{OS}$  vs LOW DOSE RATE RADIATION

## Applications Information

### Functional Description

The ISL70419SEH contains four, low noise precision op amps. These devices are fabricated in a new precision 40V complementary bipolar DI process. A super-beta NPN input stage with input bias current cancellation provides low input bias current (180pA typical), low input offset voltage (13 $\mu$ V typical), low input noise voltage (8nV/ $\sqrt{Hz}$ ), and low 1/f noise corner frequency (~8Hz). These amplifiers also feature high open loop gain (14kV/mV) for excellent CMRR (145dB) and THD+N performance (0.0005% at 3.5VRMS, 1kHz into 2k $\Omega$ ). A complementary bipolar output stage enables high capacitive load drive without external compensation.

### Operating Voltage Range

The devices are designed to operate over the 4.5V ( $\pm 2.25V$ ) to 36V ( $\pm 18V$ ) voltage range and are fully characterized at 10V ( $\pm 5V$ ) and 30V ( $\pm 15V$ ). The Power Supply Rejection Ratio typically exceeds 140dB over the full operating voltage range and 120dB minimum over the -55°C to +125°C temperature range. The worst case common mode input voltage range over-temperature is 2V to each rail. With  $\pm 15V$  supplies, CMRR performance is typically >130dB over-temperature. The minimum CMRR performance over the -55°C to +125°C temperature range is >120dB for power supply voltages from  $\pm 5V$  (10V) to  $\pm 15V$  (30V).

### Input Performance

The super-beta NPN input pair provides excellent frequency response while maintaining high input precision. High NPN beta (>1000) reduces input bias current while maintaining good frequency response, low input bias current and low noise. Input bias cancellation circuits provide additional bias current reduction to <5nA, and excellent temperature stabilization. Figures 6 through 8 show the high degree of bias current stability at  $\pm 5V$  and  $\pm 15V$  supplies that is maintained across the -55°C to +125°C temperature range. The low bias current TC also produces very low input offset current TC, which reduces DC input offset errors in precision, high impedance amplifiers.

The +25°C maximum input offset voltage ( $V_{OS}$ ) is 75 $\mu$ V at  $\pm 15V$  supplies. Input offset voltage temperature coefficients ( $V_{OS}TC$ ) is a maximum of  $\pm 1.0\mu$ V/°C. The  $V_{OS}$  temperature behavior is smooth (Figures 3 through 4) maintaining constant TC across the entire temperature range.

### Input ESD Diode Protection

The input terminals (IN+ and IN-) have internal ESD protection diodes to the positive and negative supply rails, series connected 500 $\Omega$  current limiting resistors and an anti-parallel diode pair across the inputs (Figure 53).

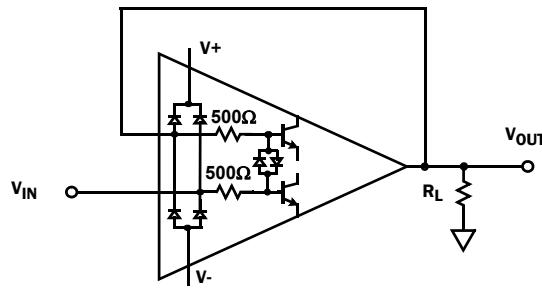


FIGURE 53. INPUT ESD DIODE CURRENT LIMITING- UNITY GAIN

The series resistors limit the high feed-through currents that can occur in pulse applications when the input dV/dT exceeds the 0.5V/ $\mu$ s slew rate of the amplifier. Without the series resistors, the input can forward-bias the anti-parallel diodes causing current to flow to the output resulting in severe distortion and possible diode failure.

[Figure 36](#) provides an example of distortion free large signal response using a 4Vp-p input pulse with an input rise time of <1ns. The series resistors enable the input differential voltage to be equal to the maximum power supply voltage (36V) without damage.

In applications where one or both amplifier input terminals are at risk of exposure to high voltages beyond the power supply rails, current limiting resistors may be needed at the input terminal to limit the current through the power supply ESD diodes to 20mA max.

### Output Current Limiting

The output current is internally limited to approximately  $\pm 45mA$  at +25°C and can withstand a short circuit to either rail as long as the power dissipation limits are not exceeded. This applies to only 1 amplifier at a time for the quad op amp. Continuous operation under these conditions may degrade long term reliability. [Figures 15](#) and [Figure 16 on page 10](#) show the current limit variation with temperature.

### Output Phase Reversal

Output phase reversal is a change of polarity in the amplifier transfer function when the input voltage exceeds the supply voltage. The ISL70419SEH is immune to output phase reversal, even when the input voltage is 1V beyond the supplies.

## Power Dissipation

It is possible to exceed the +150°C maximum junction temperatures under certain load and power supply conditions. It is therefore important to calculate the maximum junction temperature ( $T_{JMAX}$ ) for all applications to determine if power supply voltages, load conditions, or package type need to be modified to remain in the safe operating area. These parameters are related using [Equation 1](#):

$$T_{JMAX} = T_{MAX} + \theta_{JA} \times P_{D_{MAXTOTAL}} \quad (\text{EQ. 1})$$

where:

- $P_{D_{MAXTOTAL}}$  is the sum of the maximum power dissipation of each amplifier in the package ( $P_{D_{MAX}}$ )
- $P_{D_{MAX}}$  for each amplifier can be calculated using [Equation 2](#):

$$P_{D_{MAX}} = V_S \times I_{qMAX} + (V_S - V_{OUTMAX}) \times \frac{V_{OUTMAX}}{R_L} \quad (\text{EQ. 2})$$

where:

- $T_{MAX}$  = Maximum ambient temperature
- $\theta_{JA}$  = Thermal resistance of the package
- $P_{D_{MAX}}$  = Maximum power dissipation of 1 amplifier
- $V_S$  = Total supply voltage
- $I_{qMAX}$  = Maximum quiescent supply current of 1 amplifier
- $V_{OUTMAX}$  = Maximum output voltage swing of the application

## Package Characteristics

### Weight of Packaged Device

0.6043 Grams (Typical)

### Lid Characteristics

Finish: Gold

Potential: Unbiased; tied to EPAD

Case Isolation to Any Lead:  $20 \times 10^9 \Omega$  (min)

## Die Characteristics

### Die Dimensions

2406 $\mu$ m x 2935 $\mu$ m (95mils x 116mils)

Thickness: 483 $\mu$ m  $\pm$  25 $\mu$ m (19mils  $\pm$  1 mil)

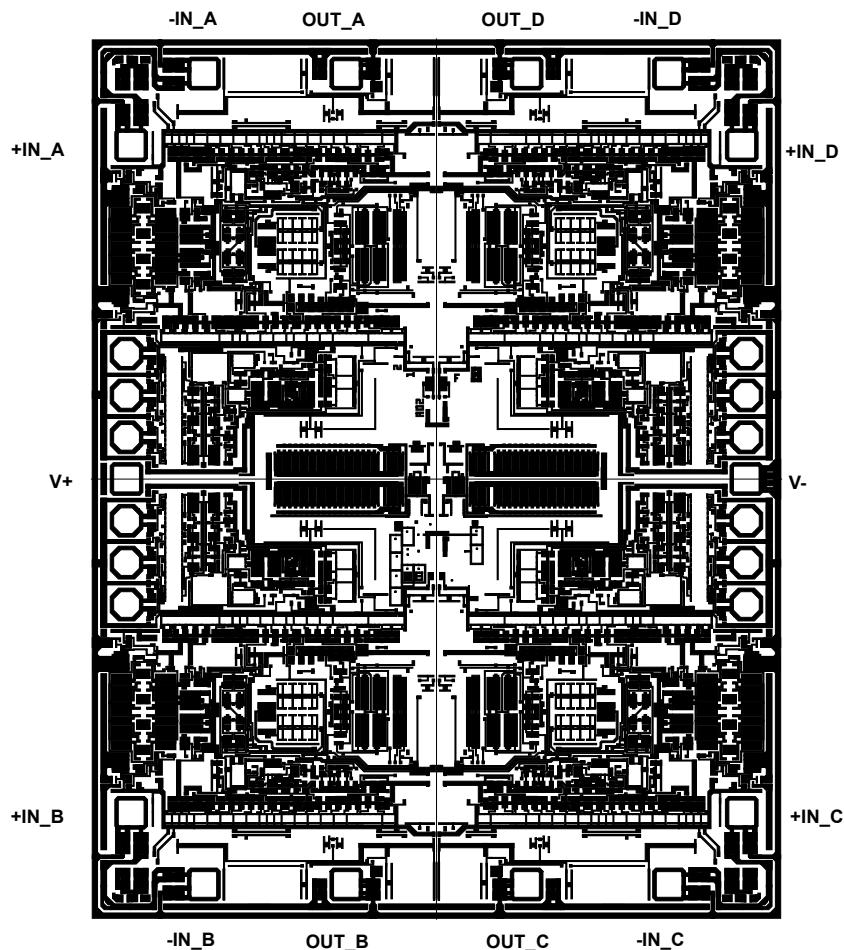
### Interface Materials

#### GLASSIVATION

Type: Nitrox

Thickness: 15k $\text{\AA}$

## Metalization Mask Layout



### TOP METALLIZATION

Type: AlCu (99.5%/0.5%)

Thickness: 30k $\text{\AA}$

### BACKSIDE FINISH

Silicon

### PROCESS

Dielectrically Isolated Complementary Bipolar - PR40

## ASSEMBLY RELATED INFORMATION

### SUBSTRATE POTENTIAL

Floating

## ADDITIONAL INFORMATION

### WORST CASE CURRENT DENSITY

<  $2 \times 10^5$  A/cm<sup>2</sup>

# ISL70419SEH

TABLE 1. DIE LAYOUT X-Y COORDINATES

| PAD NAME | PAD NUMBER | X<br>( $\mu\text{m}$ ) | Y<br>( $\mu\text{m}$ ) | dX<br>( $\mu\text{m}$ ) | dY<br>( $\mu\text{m}$ ) | BOND WIRES<br>PER PAD |
|----------|------------|------------------------|------------------------|-------------------------|-------------------------|-----------------------|
| OUT_A    | 3          | -445.5                 | 1308.5                 | 70                      | 70                      | 1                     |
| -IN_A    | 4          | -815                   | 1308.5                 | 70                      | 70                      | 1                     |
| +IN_A    | 5          | -1040.5                | 1092                   | 70                      | 70                      | 1                     |
| V+       | 9          | -1044                  | 0                      | 70                      | 70                      | 1                     |
| +IN_B    | 13         | -1040.5                | -1092                  | 70                      | 70                      | 1                     |
| -IN_B    | 14         | -815                   | -1308.5                | 70                      | 70                      | 1                     |
| OUT_B    | 15         | -445.5                 | -1308.5                | 70                      | 70                      | 1                     |
| OUT_C    | 16         | 445.5                  | -1308.5                | 70                      | 70                      | 1                     |
| -IN_C    | 17         | 815                    | -1308.5                | 70                      | 70                      | 1                     |
| +IN_C    | 18         | 1040.5                 | -1092                  | 70                      | 70                      | 1                     |
| V-       | 22         | 1044                   | 0                      | 70                      | 70                      | 1                     |
| +IN_D    | 26         | 1040.5                 | 1092                   | 70                      | 70                      | 1                     |
| -IN_D    | 1          | 815                    | 1308.5                 | 70                      | 70                      | 1                     |
| OUT_D    | 2          | 445.5                  | 1308.5                 | 70                      | 70                      | 1                     |

NOTE:

6. Origin of coordinates is the center of die.

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest Revision.

| DATE          | REVISION | CHANGE  |
|---------------|----------|---|
| July 11, 2014 | FN8653.1 | Modified in Features on <a href="#">page 1</a><br>SEL/SEB LET <sub>TH</sub> (VS = ±36V). . . . . 86.4 MeV•cm <sup>2</sup> /mg<br>to<br>SEB LET <sub>TH</sub> (VS = ±18V). . . . . 86.4 MeV•cm <sup>2</sup> /mg<br><br>Added in Features on <a href="#">page 1</a><br>"SEL Immune (SOI Process)"<br>under in the radiation environment section |
| June 24, 2014 | FN8653.0 | Initial Release   |

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# Package Outline Drawing

K14.C

14 LEAD CERAMIC METAL SEAL FLATPACK PACKAGE

Rev 0, 9/12

